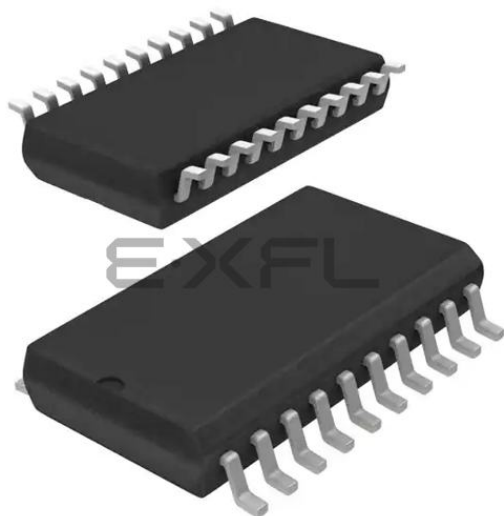




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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	LED, LVD, POR, PWM
Number of I/O	15
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 12x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc908jk3mdwe



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1.3 Features

Features of the MC68H(R)C908JL3 include the following:

- High-performance M68HC08 architecture
- Fully upward-compatible object code with M6805, M146805, and M68HC05 Families
- Low-power design; fully static with stop and wait modes
- 5V and 3V operating voltages
- 8MHz internal bus operation
- RC-oscillator circuit or crystal-oscillator options
- In-system FLASH programming
- FLASH security¹
- User FLASH memory
 - 4096 bytes for MC68H(R)C908JL3/JK3
 - 1536 bytes for MC68H(R)C908JK1
- 128 bytes of on-chip random-access memory (RAM)
- 2-channel, 16-bit timer interface module (TIM)
- 12-channel, 8-bit analog-to-digital converter (ADC)
- 23 general purpose I/O ports for MC68H(R)C908JL3:
 - 7 keyboard interrupt with internal pull-up
 - 10 LED drivers
 - 2 × 25mA open-drain I/O with pull-up
 - 2 ICAP/OCAP/PWM
- 15 general purpose I/O ports for MC68H(R)C908JK3/JK1:
 - 1 keyboard interrupt with internal pull-up (with RC oscillator option selected)
 - 4 LED drivers
 - 2 × 25mA open-drain I/O with pull-up
 - 2 ICAP/OCAP/PWM

1. No security feature is absolutely secure. However, Freescale's strategy is to make reading or copying the FLASH difficult for unauthorized users.

- System protection features:
 - Optional computer operating properly (COP) reset
 - Optional low-voltage detection with reset and selectable trip points for 3V and 5V operation.
 - Illegal opcode detection with reset
 - Illegal address detection with reset
- Master reset pin with internal pull-up and power-on reset
- $\overline{\text{IRQ1}}$ with programmable pull-up and schmitt-trigger input
- 28-pin PDIP and 28-pin SOIC packages for MC68H(R)C908JL3
- 20-pin PDIP and 20-pin SOIC packages for MC68H(R)C908JK3/JK1

Features of the CPU08 include the following:

- Enhanced HC05 programming model
- Extensive loop control functions
- 16 addressing modes (eight more than the HC05)
- 16-bit index register and stack pointer
- Memory-to-memory data transfers
- Fast 8×8 multiply instruction
- Fast 16/8 divide instruction
- Binary-coded decimal (BCD) instructions
- Optimization for controller applications
- Efficient C language support

1.4 MCU Block Diagram

Figure 1-1 shows the structure of the MC68H(R)C908JL3.

Table 2-1. Vector Addresses

Vector Priority	Vector	Address	Vector
Lowest  Highest	IF15	\$FFDE	ADC Conversion Complete Vector (High)
		\$FFDF	ADC Conversion Complete Vector (Low)
	IF14	\$FFE0	Keyboard Vector (High)
		\$FFE1	Keyboard Vector (Low)
	IF13 to IF6	—	Not Used
	IF5	\$FFF2	TIM Overflow Vector (High)
		\$FFF3	TIM Overflow Vector (Low)
	IF4	\$FFF4	TIM Channel 1 Vector (High)
		\$FFF5	TIM Channel 1 Vector (Low)
	IF3	\$FFF6	TIM Channel 0 Vector (High)
		\$FFF7	TIM Channel 0 Vector (Low)
	IF2	—	Not Used
	IF1	\$FFFA	$\overline{\text{IRQ}}$ Vector (High)
		\$FFFB	$\overline{\text{IRQ}}$ Vector (Low)
	—	\$FFFC	SWI Vector (High)
		\$FFFD	SWI Vector (Low)
—	\$FFFE	Reset Vector (High)	
	\$FFFF	Reset Vector (Low)	

Table 6-1. Instruction Set Summary

Source Form	Operation	Description	Effect on CCR						Address Mode	Opcode	Operand	Cycles
			V	H	I	N	Z	C				
CMP #opr CMP opr CMP opr CMP opr,X CMP opr,X CMP ,X CMP opr,SP CMP opr,SP	Compare A with M	(A) – (M)	↑	–	–	↑	↑	↑	IMM DIR EXT IX2 IX1 IX SP1 SP2	A1 B1 C1 D1 E1 F1 9EE1 9ED1	ii dd hh ll ee ff ff ff ee ff	2 3 4 4 3 2 4 5
COM opr COMA COMX COM opr,X COM ,X COM opr,SP	Complement (One's Complement)	$M \leftarrow (\overline{M}) = \$FF - (M)$ $A \leftarrow (\overline{A}) = \$FF - (M)$ $X \leftarrow (\overline{X}) = \$FF - (M)$ $M \leftarrow (\overline{M}) = \$FF - (M)$ $M \leftarrow (\overline{M}) = \$FF - (M)$ $M \leftarrow (\overline{M}) = \$FF - (M)$	0	–	–	↑	↑	1	DIR INH INH IX1 IX SP1	33 43 53 63 73 9E63	dd ff ff ff	4 1 1 4 3 5
CPHX #opr CPHX opr	Compare H:X with M	(H:X) – (M:M + 1)	↑	–	–	↑	↑	↑	IMM DIR	65 75	ii ii+1 dd	3 4
CPX #opr CPX opr CPX opr CPX ,X CPX opr,X CPX opr,X CPX opr,SP CPX opr,SP	Compare X with M	(X) – (M)	↑	–	–	↑	↑	↑	IMM DIR EXT IX2 IX1 IX SP1 SP2	A3 B3 C3 D3 E3 F3 9EE3 9ED3	ii dd hh ll ee ff ff ff ee ff	2 3 4 4 3 2 4 5
DAA	Decimal Adjust A	(A) ₁₀	U	–	–	↑	↑	↑	INH	72		2
DBNZ opr,rel DBNZ rel DBNZX rel DBNZ opr,X,rel DBNZ X,rel DBNZ opr,SP,rel	Decrement and Branch if Not Zero	$A \leftarrow (A) - 1$ or $M \leftarrow (M) - 1$ or $X \leftarrow (X) - 1$ $PC \leftarrow (PC) + 3 + rel ? (result) \neq 0$ $PC \leftarrow (PC) + 2 + rel ? (result) \neq 0$ $PC \leftarrow (PC) + 2 + rel ? (result) \neq 0$ $PC \leftarrow (PC) + 3 + rel ? (result) \neq 0$ $PC \leftarrow (PC) + 2 + rel ? (result) \neq 0$ $PC \leftarrow (PC) + 4 + rel ? (result) \neq 0$	–	–	–	–	–	–	DIR INH INH IX1 IX SP1	3B 4B 5B 6B 7B 9E6B	dd rr rr rr ff rr rr ff rr	5 3 3 5 4 6
DEC opr DECA DECX DEC opr,X DEC ,X DEC opr,SP	Decrement	$M \leftarrow (M) - 1$ $A \leftarrow (A) - 1$ $X \leftarrow (X) - 1$ $M \leftarrow (M) - 1$ $M \leftarrow (M) - 1$ $M \leftarrow (M) - 1$	↑	–	–	↑	↑	–	DIR INH INH IX1 IX SP1	3A 4A 5A 6A 7A 9E6A	dd ff ff	4 1 1 4 3 5
DIV	Divide	$A \leftarrow (H:A)/(X)$ H ← Remainder	–	–	–	–	↑	↑	INH	52		7

Table 6-1. Instruction Set Summary

Source Form	Operation	Description	Effect on CCR						Address Mode	Opcode	Operand	Cycles
			V	H	I	N	Z	C				
A	Accumulator	<i>n</i>										
C	Carry/borrow bit	<i>opr</i>										
CCR	Condition code register	PC										
dd	Direct address of operand	PCH										
dd rr	Direct address of operand and relative offset of branch instruction	PCL										
DD	Direct to direct addressing mode	REL										
DIR	Direct addressing mode	<i>rel</i>										
DIX+	Direct to indexed with post increment addressing mode	<i>rr</i>										
ee ff	High and low bytes of offset in indexed, 16-bit offset addressing	SP1										
EXT	Extended addressing mode	SP2										
ff	Offset byte in indexed, 8-bit offset addressing	SP										
H	Half-carry bit	U										
H	Index register high byte	V										
hh ll	High and low bytes of operand address in extended addressing	X										
I	Interrupt mask	Z										
ii	Immediate operand byte	&										
IMD	Immediate source to direct destination addressing mode											
IMM	Immediate addressing mode	⊕										
INH	Inherent addressing mode	()										
IX	Indexed, no offset addressing mode	−()										
IX+	Indexed, no offset, post increment addressing mode	#										
IX+D	Indexed with post increment to direct addressing mode	«										
IX1	Indexed, 8-bit offset addressing mode	←										
IX1+	Indexed, 8-bit offset, post increment addressing mode	?										
IX2	Indexed, 16-bit offset addressing mode	:										
M	Memory location	↑										
N	Negative bit	—										

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7.8.1	Break Status Register (BSR)	91
7.8.2	Reset Status Register (RSR)	92
7.8.3	Break Flag Control Register (BFCR)	94

7.2 Introduction

This section describes the system integration module (SIM), which supports up to 24 external and/or internal interrupts. Together with the CPU, the SIM controls all MCU activities. A block diagram of the SIM is shown in [Figure 7-1](#). [Figure 7-2](#) is a summary of the SIM I/O registers. The SIM is a system state controller that coordinates CPU and exception timing. The SIM is responsible for:

- Bus clock generation and control for CPU and peripherals
 - Stop/wait/reset/break entry and recovery
 - Internal clock control
- Master reset control, including power-on reset (POR) and COP timeout
- Interrupt control:
 - Acknowledge timing
 - Arbitration control timing
 - Vector address generation
- CPU enable/disable timing
- Modular architecture expandable to 128 interrupt sources

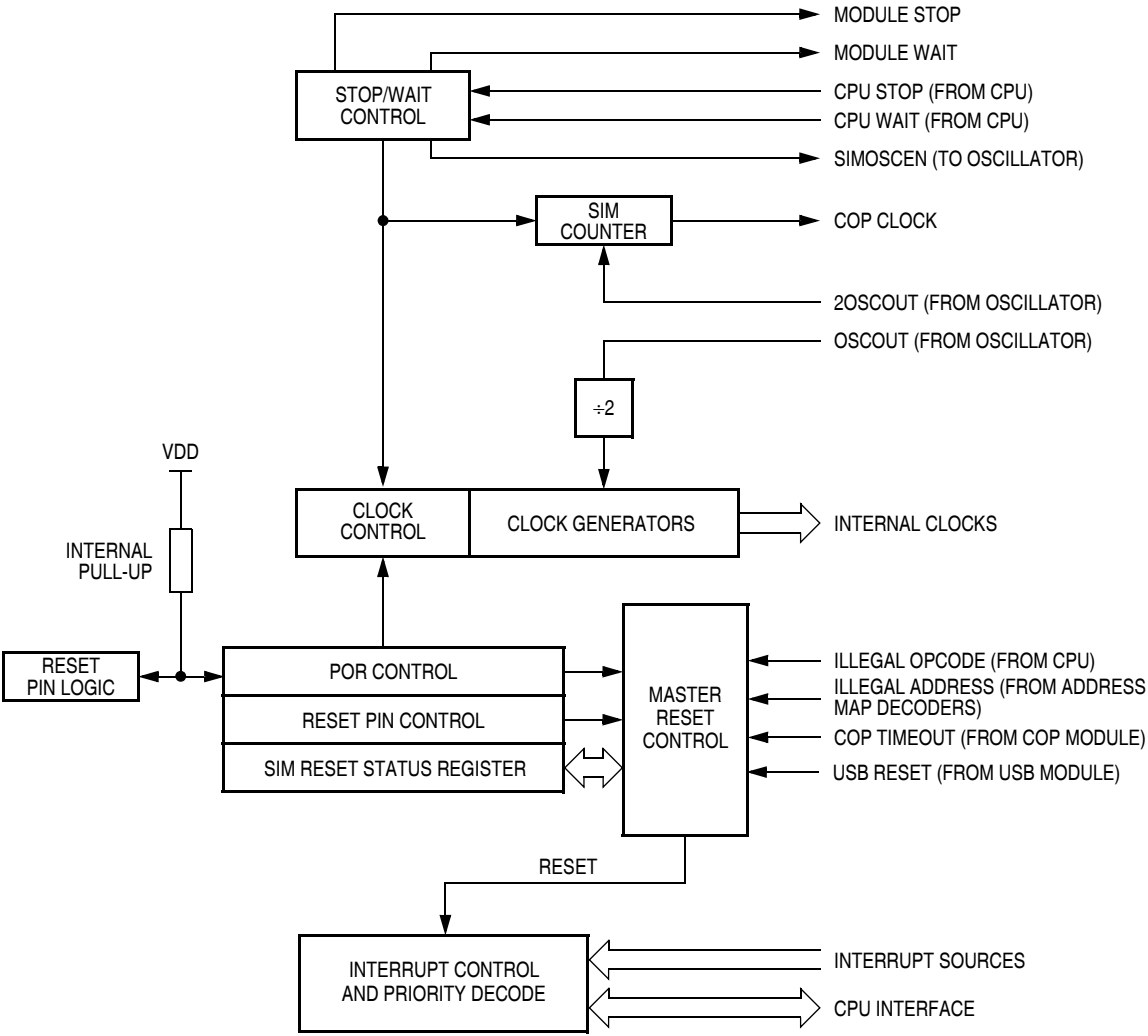


Figure 7-1. SIM Block Diagram

Table 7-1. Signal Name Conventions

Signal Name	Description
2OSCMOUT	Buffered clock from the X-tal oscillator circuit or the RC oscillator circuit.
OSCMOUT	The 2OSCMOUT frequency divided by two. This signal is again divided by two in the SIM to generate the internal bus clocks. (Bus clock = 2OSCMOUT ÷ 4)
IAB	Internal address bus
IDB	Internal data bus
PORRST	Signal from the power-on reset module to the SIM
IRST	Internal reset signal
R/W	Read/write signal

7.4.2.2 Computer Operating Properly (COP) Reset

An input to the SIM is reserved for the COP reset signal. The overflow of the COP counter causes an internal reset and sets the COP bit in the reset status register (RSR). The SIM actively pulls down the $\overline{\text{RST}}$ pin for all internal reset sources.

To prevent a COP module time-out, write any value to location \$FFFF. Writing to location \$FFFF clears the COP counter and stages 12 through 5 of the SIM counter. The SIM counter output, which occurs at least every $(2^{12} - 2^4)$ 2OSCOU cycles, drives the COP counter. The COP should be serviced as soon as possible out of reset to guarantee the maximum amount of time before the first time-out.

The COP module is disabled if the $\overline{\text{RST}}$ pin or the $\overline{\text{IRQ1}}$ pin is held at $V_{\text{DD}} + V_{\text{HI}}$ while the MCU is in monitor mode. The COP module can be disabled only through combinational logic conditioned with the high voltage signal on the $\overline{\text{RST}}$ or the $\overline{\text{IRQ1}}$ pin. This prevents the COP from becoming disabled as a result of external noise. During a break state, $V_{\text{DD}} + V_{\text{HI}}$ on the $\overline{\text{RST}}$ pin disables the COP module.

7.4.2.3 Illegal Opcode Reset

The SIM decodes signals from the CPU to detect illegal instructions. An illegal instruction sets the ILOP bit in the reset status register (RSR) and causes a reset.

If the stop enable bit, STOP, in the mask option register is logic zero, the SIM treats the STOP instruction as an illegal opcode and causes an illegal opcode reset. The SIM actively pulls down the $\overline{\text{RST}}$ pin for all internal reset sources.

7.4.2.4 Illegal Address Reset

An opcode fetch from an unmapped address generates an illegal address reset. The SIM verifies that the CPU is fetching an opcode prior to asserting the ILAD bit in the reset status register (RSR) and resetting the MCU. A data fetch from an unmapped address does not generate a reset. The SIM actively pulls down the $\overline{\text{RST}}$ pin for all internal reset sources.

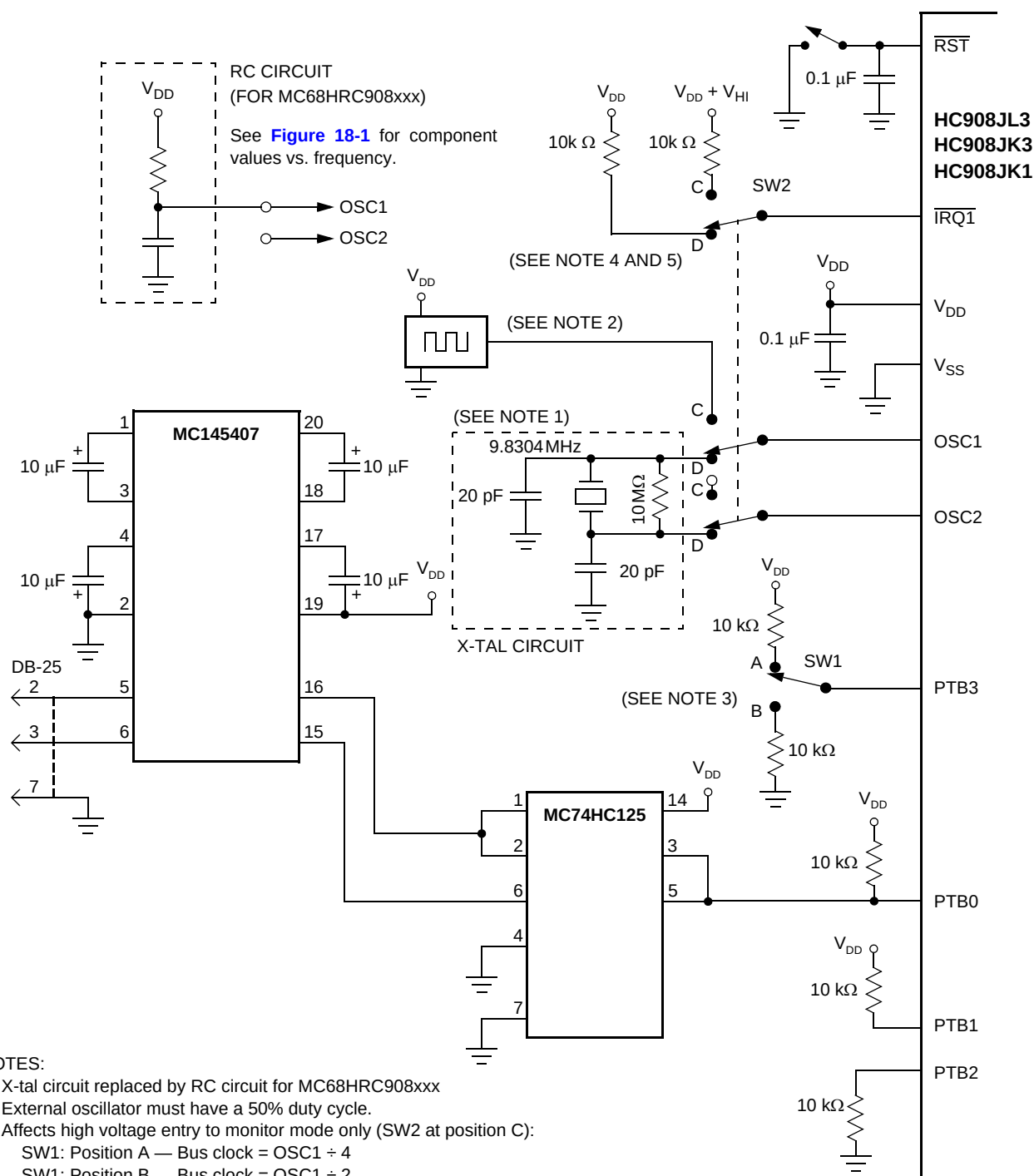


Figure 9-1. Monitor Mode Circuit

If TIM functions are not required during wait mode, reduce power consumption by stopping the TIM before executing the WAIT instruction.

10.8 TIM During Break Interrupts

A break interrupt stops the TIM counter.

The system integration module (SIM) controls whether status bits in other modules can be cleared during the break state. The BCFE bit in the break flag control register (BFCR) enables software to clear status bits during the break state. (See [7.8.3 Break Flag Control Register \(BFCR\)](#).)

To allow software to clear status bits during a break interrupt, write a logic one to the BCFE bit. If a status bit is cleared during the break state, it remains cleared when the MCU exits the break state.

To protect status bits during the break state, write a logic zero to the BCFE bit. With BCFE at logic zero (its default state), software can read and write I/O registers during the break state without affecting status bits. Some status bits have a two-step read/write clearing procedure. If software does the first step on such a bit before the break, the bit cannot change during the break state as long as BCFE is at logic zero. After the break, doing the second step clears the status bit.

10.9 I/O Signals

Port D shares two of its pins with the TIM. The two TIM channel I/O pins are PTD4/TCH0 and PTD5/TCH1.

Each channel I/O pin is programmable independently as an input capture pin or an output compare pin. PTD4/TCH0 can be configured as a buffered output compare or buffered PWM pin.

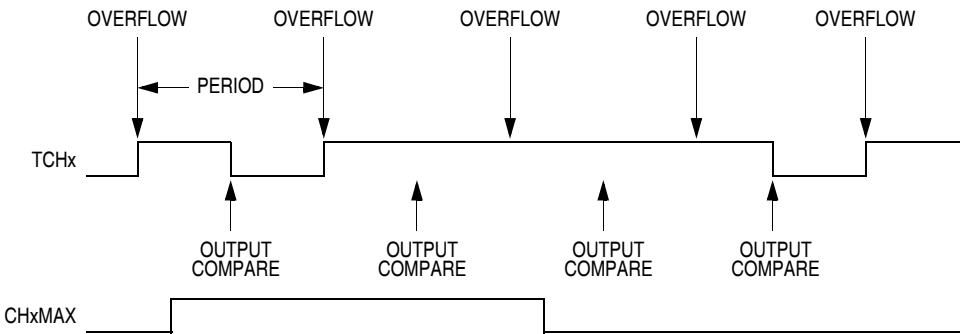


Figure 10-8. CHxMAX Latency

10.10.5 TIM Channel Registers (TCH0H/L:TCH1H/L)

These read/write registers contain the captured TIM counter value of the input capture function or the output compare value of the output compare function. The state of the TIM channel registers after reset is unknown.

In input capture mode ($MSxB:MSxA = 0:0$), reading the high byte of the TIM channel x registers (TCHxH) inhibits input captures until the low byte (TCHxL) is read.

In output compare mode ($MSxB:MSxA \neq 0:0$), writing to the high byte of the TIM channel x registers (TCHxH) inhibits output compares until the low byte (TCHxL) is written.

Section 11. Analog-to-Digital Converter (ADC)

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11.2 Introduction

This section describes the analog-to-digital converter (ADC). The ADC is an 8-bit, 12-channels analog-to-digital converter.

Table 11-1. MUX Channel Select

CH4	CH3	CH2	CH1	CH0	ADC Channel	Input Select
0	0	0	0	0	ADC0	PTB0
0	0	0	0	1	ADC1	PTB1
0	0	0	1	0	ADC2	PTB2
0	0	0	1	1	ADC3	PTB3
0	0	1	0	0	ADC4	PTB4
0	0	1	0	1	ADC5	PTB5
0	0	1	1	0	ADC6	PTB6
0	0	1	1	1	ADC7	PTB7
0	1	0	0	0	ADC8	PTD3
0	1	0	0	1	ADC9	PTD2
0	1	0	1	0	ADC10	PTD1
0	1	0	1	1	ADC11	PTD0
0	1	1	0	0	—	Unused (see Note 1)
:	:	:	:	:		
1	1	0	1	0	—	Reserved
1	1	0	1	1	—	Unused
1	1	1	0	0	—	V _{DDA} (see Note 2)
1	1	1	0	1	—	V _{SSA} (see Note 2)
1	1	1	1	0	—	ADC power off
1	1	1	1	1	—	ADC power off

NOTES:

1. If any unused channels are selected, the resulting ADC conversion will be unknown.
2. The voltage levels supplied from internal reference nodes as specified in the table are used to verify the operation of the ADC converter both in production test and for user applications.

11.8.2 ADC Data Register

One 8-bit result register is provided. This register is updated each time an ADC conversion completes.

12.6 Port D

Port D is an 8-bit special function port that shares two of its pins with Timer Interface Module, (see [Section 10.](#)) and shares four of its pins with Analog to Digital Conversion Module (see [Section 11.](#)). PTD6 and PTD7 each has high current drive (25mA sink) and programmable pull-up. PTD2, PTD3, PTD6 and PTD7 each has LED driving capability.

12.6.1 Port D Data Register (PTD)

The port D data register contains a data latch for each of the eight port D pins.

Address:	\$0003							
	Bit 7	6	5	4	3	2	1	Bit 0
Read:	PTD7	PTD6	PTD5	PTD4	PTD3	PTD2	PTD1	PTD0
Write:	PTD7	PTD6	PTD5	PTD4	PTD3	PTD2	PTD1	PTD0
Reset:								
Additional Functions	LED	LED			LED	LED		
					ADC8	ADC9	ADC10	ADC11
			TCH1	TCH0				
	25mA sink (Slow Edge)	25mA sink (Slow Edge)						
	5k pull-up	5k pull-up						

Figure 12-9. Port D Data Register (PTD)

PTD[7:0] — Port D Data Bits

These read/write bits are software programmable. Data direction of each port D pin is under the control of the corresponding bit in data direction register D. Reset has no effect on port D data.

14.5 Wait Mode

The keyboard modules remain active in wait mode. Clearing the IMASKK bit in the keyboard status and control register enables keyboard interrupt requests to bring the MCU out of wait mode.

14.6 Stop Mode

The keyboard module remains active in stop mode. Clearing the IMASKK bit in the keyboard status and control register enables keyboard interrupt requests to bring the MCU out of stop mode.

14.7 Keyboard Module During Break Interrupts

The system integration module (SIM) controls whether the keyboard interrupt latch can be cleared during the break state. The BCFE bit in the break flag control register (BFCR) enables software to clear status bits during the break state.

To allow software to clear the keyboard interrupt latch during a break interrupt, write a logic 1 to the BCFE bit. If a latch is cleared during the break state, it remains cleared when the MCU exits the break state.

To protect the latch during the break state, write a logic 0 to the BCFE bit. With BCFE at logic 0 (its default state), writing to the keyboard acknowledge bit (ACKK) in the keyboard status and control register during the break state has no effect.

17.5.2 Break Address Registers

The break address registers contain the high and low bytes of the desired breakpoint address. Reset clears the break address registers.

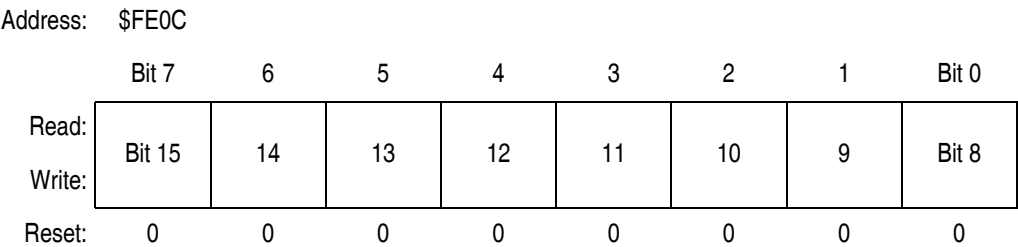


Figure 17-4. Break Address Register High (BRKH)

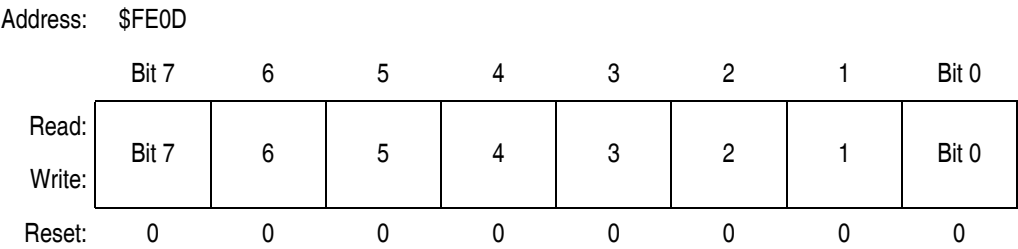


Figure 17-5. Break Address Register Low (BRKL)

17.5.3 Break Status Register

The break status register contains a flag to indicate that a break caused an exit from stop or wait mode.

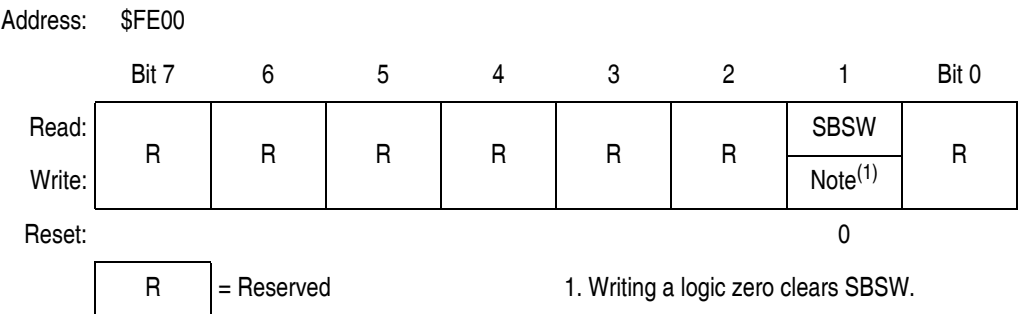


Figure 17-6. Break Status Register (BSR)

Section 19. Mechanical Specifications

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19.2 Introduction

This section gives the dimensions for:

- 20-pin plastic dual in-line package (case #738)
- 20-pin small outline integrated circuit package (case #751D)
- 28-pin plastic dual in-line package (case #710)
- 28-pin small outline integrated circuit package (case #751F)

The following figures show the latest package drawings at the time of this publication. To make sure that you have the latest package specifications, please visit the Freescale website at <http://freescale.com>. Follow or Worldwide Web on-line instructions to retrieve the current mechanical specifications.

